

TYS -Low Profile SMT Power Inductor

TYS3015 Series

FEATURES AND APPLICATIONS

Laird TYS series high current power inductors improve performance, reliability and power efficiency. A lower profile benefits consumer electronics, industrial and telecom design. Products feature extremely low DCR with greater efficiency and enable a large current in a small size. Inductors are of magnetic shielding and wire wound construction and perform in operating temperatures ranging from -40 C to 125 C including self-heating rise in temperature.

FEATURES

- Magnetic shielded structure
- Low DCR and high efficiency
- Low profile and small size
- Ferrite core with high saturation

APPLICATIONS

- DC-DC Converter and Power Suppliers
- LCD TV'S and Gaming Console
- Tablet, Notebooks, Servers and Printers
- Networking and Data storage
- GPS, Set-top-box and Base stations
- Smart meters and Medical instruments

PART NUMBER EXPLANATION



Product series Product size code code

Inductance value code (i.e. 4R7: 4.7 µH)

Tolerance % (i.e. M: \pm 20%) Catalog P.N

Standard

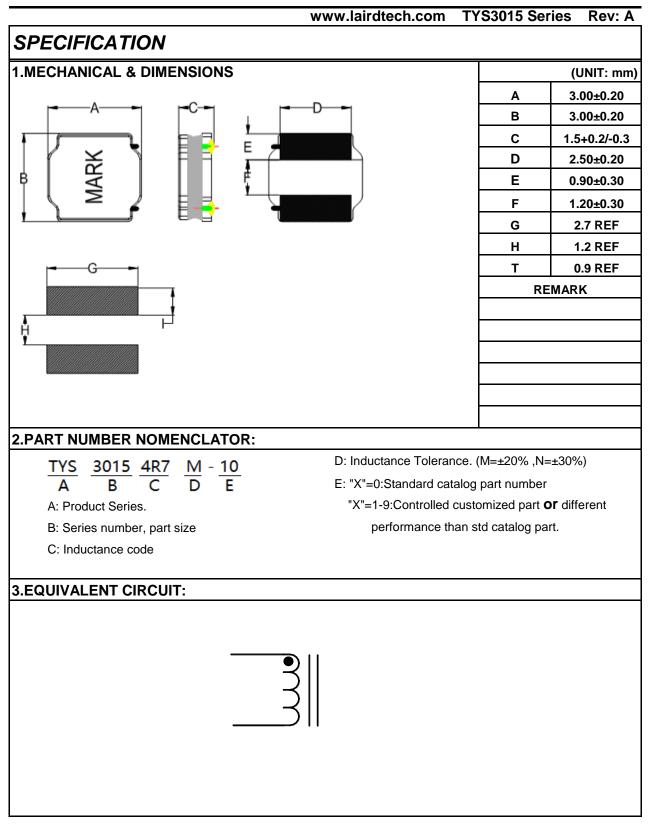
ELECTRICAL SPECIFICATIONS

- Tolerance: M: ±20% or N: ±30%
- Inductance tested at 100KHz, 1.0Vrms
- Heat Rated Current (Irms) is defined based on temperature rise approximate 40°C (ambient temperature 25±5°C)
- Saturation Current (Isat) is the DC current at which the inductance drops off approximately 30% from its value without current. (ambient temperature 25±5°C)
- Operating temperature range: -40°C~+125°C (including self-heating temperature rise)
- Storage temperature range (packaging conditions): -10°C~+40°C and RH 70%(MAX.)

Note: Heat Rated Current (Irms) is tested on a typical PCB and apply a constant current in still air. The temperature rise is dependent on the application system condition including PCB PAD pattern, trace width and thickness and adjacent components etc. It's suggested to verify the temperature rise of the component under the real operation application conditions.



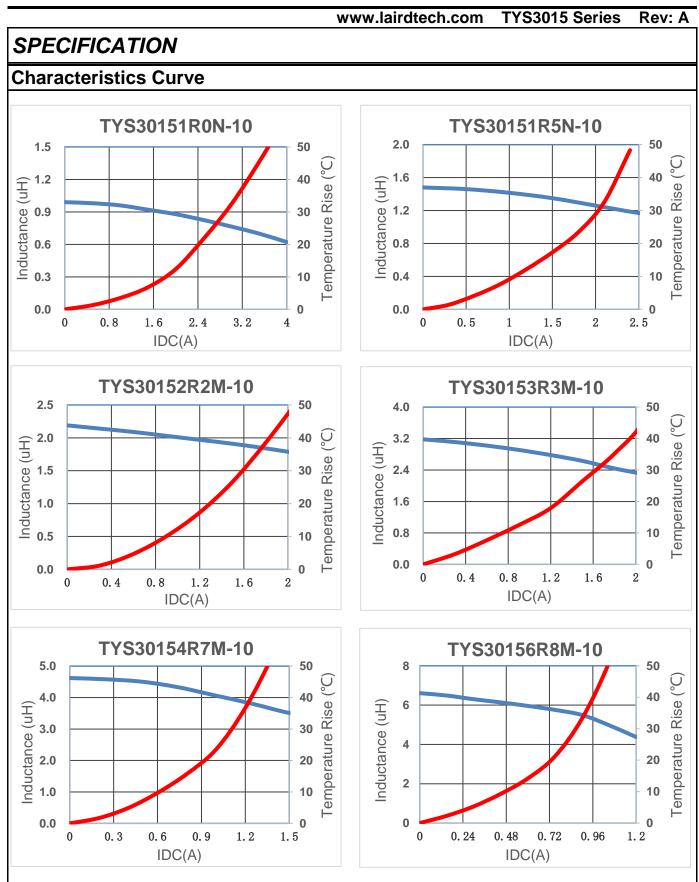




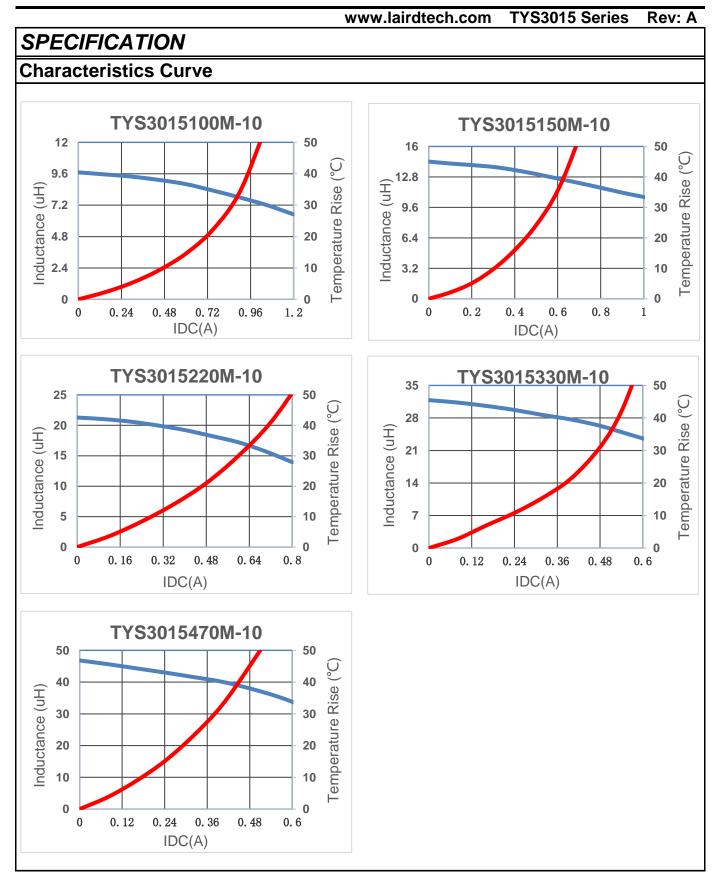


N UCTANCE (uH) 1.00 1.50 2.20 3.30 4.70 6.80 10.00 15.00 22.00 33.00 47.00	Irms(A) Typ. 2.35 1.70 1.60 1.36 1.09 0.85 0.77 0.65 0.57 0.43 0.35	Isat(A) Typ. 2.32 2.30 1.60 1.32 1.10 0.85 0.72 0.66 0.52 0.44 0.35	DCR(mΩ) TYP 35.00 50.00 60.00 88.00 125.00 200.00 250.00 380.00 460.00 820.00	DCR(mΩ) Max 45.0 65.0 78.0 114.0 162.5 260.0 325.0 494.0 598.0	SRF MHz 150 100 86 68 46 39 41 30 23
(uH) 1.00 1.50 2.20 3.30 4.70 6.80 10.00 15.00 22.00 33.00	2.35 1.70 1.60 1.36 1.09 0.85 0.77 0.65 0.57 0.43	2.32 2.30 1.60 1.32 1.10 0.85 0.72 0.66 0.52 0.44	35.00 50.00 60.00 88.00 125.00 200.00 250.00 380.00 460.00	45.0 65.0 78.0 114.0 162.5 260.0 325.0 494.0 598.0	150 100 86 68 46 39 41 30
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47.00	0.35	0.35		1066.0	20
			1250.00	1625.0	14
CATION:					
or N: ±30%					
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			ice drops off app	roximately 30%	
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e range (pac	ckaging conditio	ns): -10°C~+40°C	. and KH 70%(MA	AX.)	
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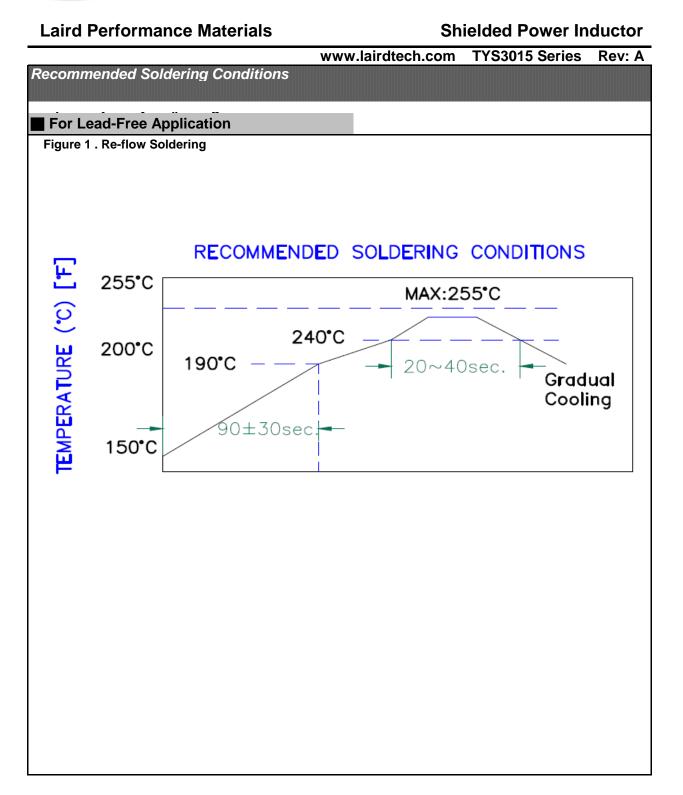
Laird Steward









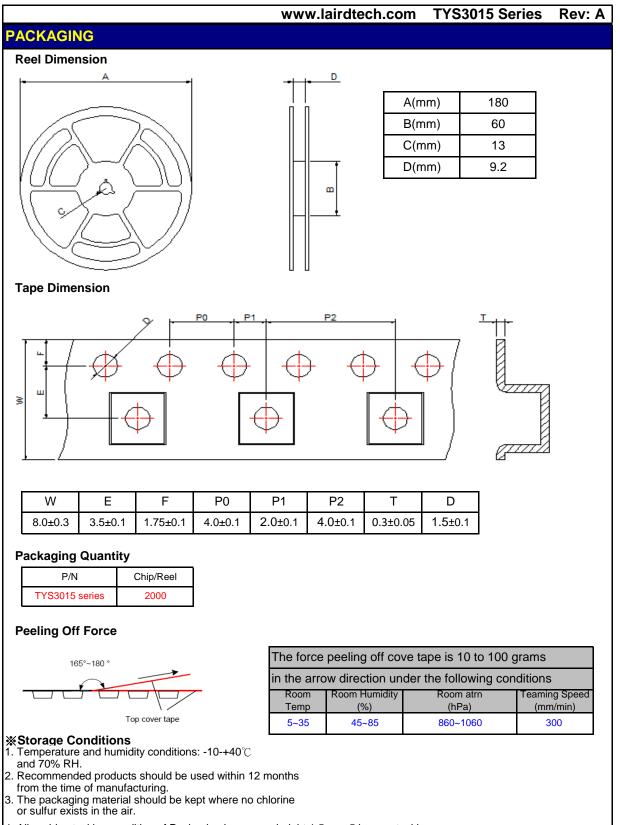




		lairdtech.com TYS3015 Series Rev: A				
Reliability and Testing Conditions / Pin Type Power Inductors SMD series(Consumer)						
Operating temperature range	-40°C ~ +125°C (Including self-temperature rise)					
Storage temperature and humidity range	-10 $^\circ\!\mathrm{C}$ to +40 $^\circ\!\mathrm{C}$, 70% RH Max					
High Temperature Exposure (Storage)	MIL-STD-202 Method 108 85±2°C, 168+24hours					
Temperature Cycling	JESD22 Method JA-104	-40°C→+85, transforming interval:20s, 100cycles				
Operational Life	MIL-PRF-2	85±°C, 168+24hours Apply maximum rated voltage and current according part drawing				
External Visual	MIL-STD-883 Method 2009	Inspect device construction, marking and workmanship. Electrical Test not required.				
Physical Dimension	JESD22 Method JB-100 Verify physical dimensions to the applicable device specification. Note: User(s) and Suppliers spec. Ele not required					
Vibration	MIL-STD-202 Method 204	10~55Hz,1.5mm, 2 hours in each 3mutually perpendicular directions (total of 6 hours)				
Resistance to Soldering Heat	MIL-STD-202 Method 210	1. Max. 260±5 [°] C,10±1s, 2 times 2.Solder Composition: Sn/3Ag/0.5Cu				
Solderability	J-STD-002	245±5℃, 5±1sec, Solder: Sn/3.0Ag/0.5Cu				
Electrical Characterization	Print Spec	Parametrically test per lot and sample size requirements, summary to show Min, Max, Mean and Standard deviation at room as well as Min and Max Operating temperatures				
Board Flex	AEC-Q200-005	2mm,30±1s				
erminal Strength(SMD) AEC-Q200-006		10N, 5S, X,Y direct				



Shielded Power Inductor



4. Allowable stacking condition of Packaging box: max height 1.5m or 5 boxes stacking